

SN54F623, SN74F623 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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- Local Bus-Latch Capability
- Noninverting Logic
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

description

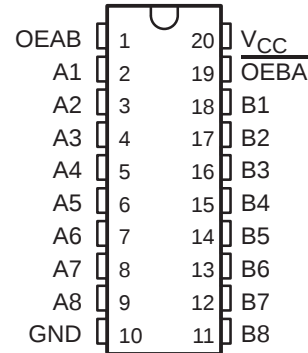
These octal bus transceivers are designed for asynchronous communication between data buses. The control function implementation allows for maximum flexibility in timing.

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the output enable (OEAB and $\overline{\text{OEBA}}$) inputs.

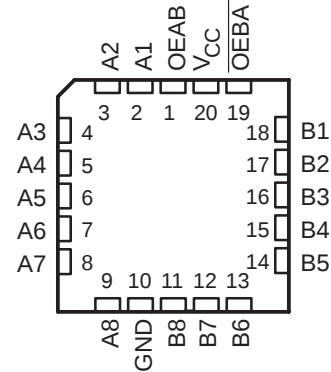
The output-enable inputs can be used to disable the device so that the buses are effectively isolated. The dual-enable configuration gives the transceivers the capability of storing data by simultaneously enabling OEAB and $\overline{\text{OEBA}}$. Each output reinforces its input in this configuration. When both OEAB and $\overline{\text{OEBA}}$ are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 in all) will remain at their last states.

The SN54F623 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74F623 is characterized for operation from 0°C to 70°C .

SN54F623 . . . J PACKAGE
SN74F623 . . . DW OR N PACKAGE
(TOP VIEW)



SN54F623 . . . FK PACKAGE
(TOP VIEW)



FUNCTION TABLE

INPUTS		OPERATION
$\overline{\text{OEBA}}$	OEAB	
L	L	B data to A bus
L	H	B data to A bus, A data to B bus
H	L	Isolation
H	H	A data to B bus

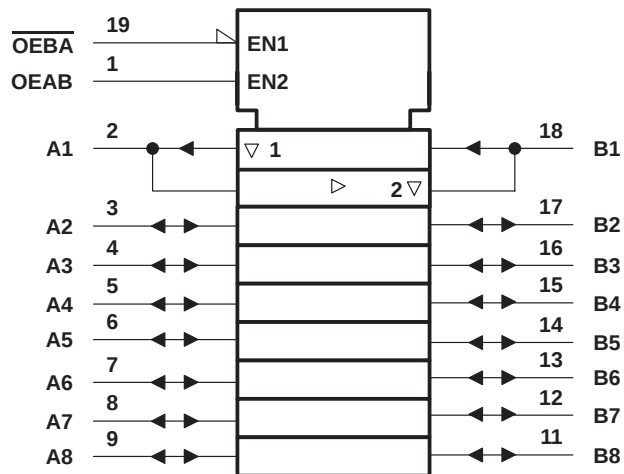
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OCTAL BUS TRANSCEIVERS

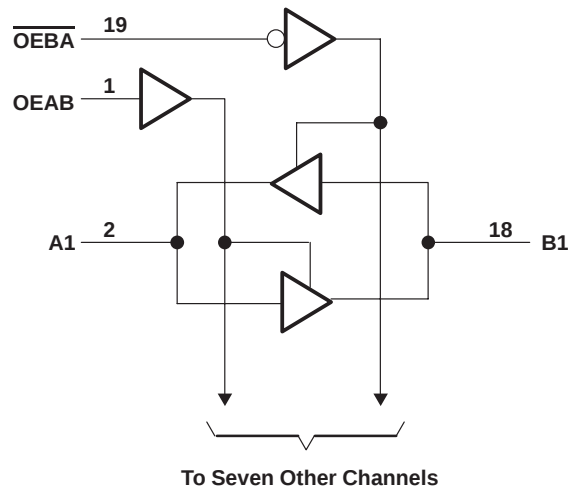
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logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (excluding I/O ports) (see Note 1)	–1.2 V to 7 V
Input current range, I_{IK}	–30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state	–0.5 V to 5.5 V
Voltage range applied to any output in the high state	–0.5 V to V_{CC}
Current into any output in the low state: SN54F623 (A1–A8)	40 mA
SN54F623 (B1–B8)	96 mA
SN74F623 (A1–A8)	48 mA
SN74F623 (B1–B8)	128 mA
Operating free-air temperature range: SN54F623	–55°C to 125°C
SN74F623	0°C to 70°C
Storage temperature range	–65°C to 150°C

‡ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

recommended operating conditions

			SN54F623			SN74F623			UNIT		
			MIN	NOM	MAX	MIN	NOM	MAX			
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V		
V _{IH}	High-level input voltage		2			2			V		
V _{IL}	Low-level input voltage		0.8			0.8			V		
I _{IK}	Input clamp current		− 18			− 18			mA		
I _{OH}	High-level output current	A1 − A8	− 3			− 3			mA		
		B1 − B8	− 12			− 15					
I _{OL}	Low-level output current	A1 − A8	20			24			mA		
		B1 − B8	48			64					
T _A	Operating free-air temperature		− 55			125			0	70	°C



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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54F623			SN74F623			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V _{IK}		V _{CC} = 4.5 V, I _I = − 18 mA		− 1.2			− 1.2			V
V _{OH}	A1–A8	V _{CC} = 4.5 V	I _{OH} = − 1 mA	2.5	3.4		2.5	3.4		V
	I _{OH} = − 3 mA		2.4	3.3		2.4	3.3			
	B1–B8		I _{OH} = − 3 mA	2.4	3.3		2.4	3.3		
			I _{OH} = − 12 mA	2	3.2					
			I _{OH} = − 15 mA				2	3.1		
Any output	V _{CC} = 4.75 V, I _{OH} = − 1 mA to − 3 mA				2.7					
V _{OL}	A1–A8	V _{CC} = 4.5 V	I _{OL} = 20 mA	0.3 0.5						V
	I _{OL} = 24 mA				0.35 0.5					
	B1–B8		I _{OL} = 48 mA	0.38 0.55						
			I _{OL} = 64 mA			0.42 0.55				
I _I	A and B ports	V _{CC} = 5.5 V	V _I = 5.5 V	1			1			mA
	OEAB or $\overline{\text{OEBA}}$		V _I = 7 V	0.1			0.1			
I _{IH} ‡	A and B ports	V _{CC} = 5.5 V, V _I = 2.7 V		70			70			μA
	OEAB or $\overline{\text{OEBA}}$		20			20				
I _{IL} ‡	A and B ports	V _{CC} = 5.5 V, V _I = 0.5 V		− 0.65			− 0.65			mA
	OEAB or $\overline{\text{OEBA}}$		− 0.6			− 0.6				
I _{OS} §	A1–A8	V _{CC} = 5.5 V, V _O = 0		− 60	− 150		− 60	− 150		mA
	B1–B8		− 100	− 225		− 100	− 225			
I _{CCH}		V _{CC} = 5.5 V, Any output = 4.5 V	110 140			110 140			mA	
I _{CCL}		V _{CC} = 5.5 V, $\overline{\text{OEBA}}$ or $\overline{\text{OEBA}}$ = 4.5 V, A1–A8 = GND	110 140			110 140			mA	
I _{CCZ}		V _{CC} = 5.5 V, $\overline{\text{OEBA}}$ or A1–A8 = 4.5 V, OEAB = GND	99 130			99 130			mA	

[†] All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

[‡] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

[§] Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

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switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 5 V, C _L = 50 pF, R _L = 500 Ω, T _A = 25°C			V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX †				UNIT
			'F623			SN54F623		SN74F623		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	A	B	1.2	3.6	5.5	1.1	6.8	1.2	6.5	ns
t _{PHL}			2.2	4.6	7	1.6	8	1.7	7.5	
t _{PLH}	B	A	1.2	3.6	5.5	1.1	6.8	1.2	6.5	ns
t _{PHL}			1.7	4.1	6.5	1.6	8	1.7	7.5	
t _{PZH}	$\overline{\text{OEBA}}$	A	3.1	8.1	10.5	2.7	12.4	3.1	12	ns
t _{PZL}			2.8	7.1	9.5	2.5	10.3	2.8	10	
t _{PHZ}	$\overline{\text{OEBA}}$	A	1.7	4.1	6.5	1.6	8.3	1.7	7.5	ns
t _{PLZ}			1.7	4.1	6.5	1.5	7.4	1.7	7	
t _{PZH}	OEAB	B	2.8	7.6	10	2.7	12	2.8	11.5	ns
t _{PZL}			2.8	6.6	9	2.8	10	2.9	9.5	
t _{PHZ}	OEAB	B	2.2	5.6	8.5	1.9	10	2.2	10	ns
t _{PLZ}			3.2	6.6	9	3.1	10.7	3.2	10	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: Load circuits and waveforms are shown in Section 1.

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